Sir:

For:

Transmitted herewith for filing is the Patent Application of:

Inventor: MAY-HO KO

FLASH PROCESS FOR STACKING POLY ETCHING

Enclosed are:						ے: ن	
x	3 sheets of drawing(s) - formal.						
x	An assignment of the invention to Taiwan Semiconductor Manufacturing Co.					16834	
	An associate power of attorney Applicant claims small entity status						
	Request & Certification under 35 USC 122(b)(2)(b)(i)						
The filing fee has been calculated as shown below:							
		(Col. 1)	(Col. 1) (Col. 2) OTHER THAN A		A SMALL ENTITY		
FOR:		NO. FILED	NO. EXTRA	RATE	FEE		
BASIC	FEE	><	\sim		\$ 770.		
TOTA	L CLAIMS	33 -20=	13	x 18 =	\$ 234.		
INDE	P CLAIMS	6 -3=	3	x 86 =	\$ 258.		
				SUB TOTAL	\$ 1,262.		
				ASSIGNMENT	\$40.		
				TOTAL	\$ 1.302.	l	
X	Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,302. A duplicate copy of this sheet is enclosed.						
X	The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any						
	overpayment	overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.					

EXPRESS MAIL CERTIFICATE

B. ACKERMAN, REG. NO. 37,761

Express Mail No.EV313927445US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Date of deposit Signature / Date

X Any additional filing fees required under 37 CFR §1.16.

X Any patent application processing fees under 37 CFR §1.17.